



Epoxy hot melt adhesive

Basis Epoxy resin (bisphenol A / epichlorohydrin and dicyandiamide)

		RRS 2110
Epikote Resin 1001	(1)	23.7
Epikote Resin 174)*		17.3
Jeffamine D-2000	(2)	19.0
SILLITIN V 85	(3)	32.0
Aerosil 200	(4)	5.0
Dyhard 100S	(5)	2.5
Dyhard UR300	(5)	0.5
Total % by weight		100.0

)* Epikote Resin 174 is no longer available. Please use a similar liquid epoxy resin (M = 378 g/mol, EEW = 189 g/eq, epoxy content = 22,8 %).

Suppliers

- (1) Westlake
- (2) Huntsman
- (3) HOFFMANN MINERAL
- (4) Evonik Industries
- (5) AlzChem

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